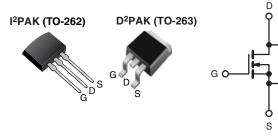


Vishay Siliconix

FREE

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	400			
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.55		
Q _g (Max.) (nC)	36			
Q _{gs} (nC)	9.9			
Q _{gd} (nC)	16			
Configuration	Single			



N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Low Gate Charge Q_g Results in Simple Drive Requirement
 Improved Cate Avalance and Dynamic dV/dt
 HALOGEN
 HALOGEN
- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High speed Power Switching

TYPICAL SMPS TOPOLOGIES

- Single Transistor Flyback Xfmr. Reset
- Single Transistor Forward Xfmr. Reset (Both for US Line Input Only)

ORDERING INFORMATION					
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)	I ² PAK (TO-262)	
Lead (Pb)-free and Halogen-free	SiHF740AS-GE3	SiHF740ASTRL-GE3 ^a	SiHF740ASTRR-GE3 ^a	SiHF740AL-GE3	
Lead (Pb)-free	IRF740ASPbF	IRF740ASTRLPbF ^a	IRF740ASTRRPbF ^a	IRF740ALPbF	
Lead (FD)-iree	SiHF740AS-E3	SiHF740ASTL-E3 ^a	SiHF740ASTR-E3a	SiHF740AL-E3	

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	400	v	
Gate-Source Voltage			V _{GS}	± 30		
Continuous Drain Current ^e	V_{GS} at 10 V $T_{C} = 25 °C$ $T_{C} = 100 °C$	T _C = 25 °C		10		
		I _D	6.3	А		
Pulsed Drain Current ^{a, e}			I _{DM}	40		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^{b, e}			E _{AS}	630	mJ	
Avalanche Current ^a			I _{AR}	10	А	
Repetiitive Avalanche Energy ^a			E _{AR}	12.5	mJ	
Maximum Power Dissipation	T _A =	25 °C	Pn	3.1	w	
	T _C =	25 °C	FD	125	vv	
Peak Diode Recovery dV/dt ^{c, e}			dV/dt	5.9	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	- °C		
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting $T_J = 25$ °C, L = 12.6 mH, $R_g = 25 \Omega$, $I_{AS} = 10$ A (see fig. 12).

c. $I_{SD} \le 10$ Å, dl/dt ≤ 330 Å/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

e. Uses IRF740A, SiHF740A data and test conditions.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient (PCB Mounted, Steady-State) ^a	R _{thJA}	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0			

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	ST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referenc	Reference to 25 °C, I _D = 1 mA ^d		0.48	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} :	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 320 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	25 250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_{\rm D} = 6.0 {\rm A}^{\rm b}$	-	-	0.55	Ω
Forward Transconductance	g fs	V _{DS} :	= 50 V, I _D = 6.0 A ^d	4.9	-	-	S
Dynamic		•			I	I	
Input Capacitance	C _{iss}	$\label{eq:VGS} \begin{array}{l} V_{GS} = 0 \ V, \\ V_{DS} = 25 \ V, \\ f = 1.0 \ \text{MHz}, \text{see fig. } 5^d \end{array}$		-	1030	-	-
Output Capacitance	C _{oss}			-	170	-	
Reverse Transfer Capacitance	C _{rss}			-	7.7	-	
Output Capacitance	C _{oss}	V _{GS} = 0 V	V _{DS} = 1.0 V, f = 1.0 MHz	-	1490	-	- pF -
			V _{DS} = 320 V, f = 1.0 MHz	-	52	-	
Effective Output Capacitance	C _{oss} eff.		$V_{DS} = 0 V \text{ to } 320 V^{c, d}$	-	61	-	
Total Gate Charge	Qg			-	-	36	
Gate-Source Charge	Q_gs	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 320 \text{ V},$ see fig. 6 and $13^{b, d}$	-	-	9.9	nC	
Gate-Drain Charge	Q _{gd}			-	-	16	1
Turn-On Delay Time	t _{d(on)}			-	10	-	
Rise Time	t _r	V _{DD} :	= 200 V, I _D = 10 A,	-	35	-	1
Turn-Off Delay Time	t _{d(off)}	$R_g = 10 \Omega$, $R_D = 19.5 \Omega$, see fig. $10^{b, d}$		-	24	-	ns
Fall Time	t _f			-	22	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	40	
Body Diode Voltage	V_{SD}	$T_J = 25 \text{ °C}, I_S = 10 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 10 A, dl/dt = 100 A/µs ^{b, d}		-	240	360	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.9	2.9	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_F				L _D)	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80 % V_{DS}.

d. Uses IRF740A, SiHF740A data and test conditions.

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10.0



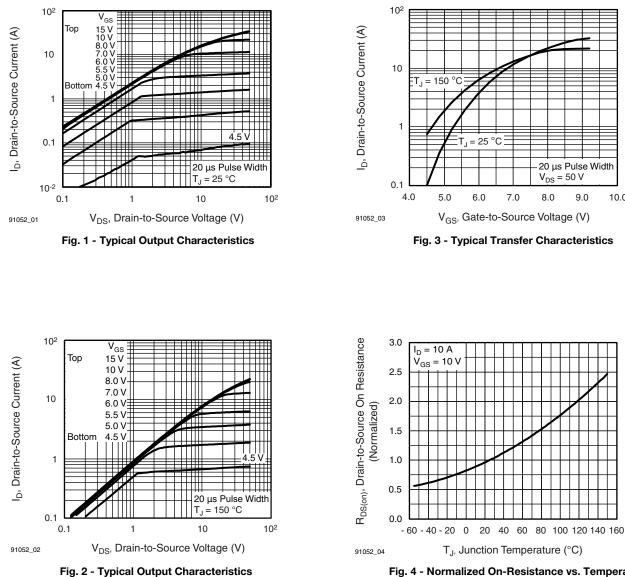


Fig. 4 - Normalized On-Resistance vs. Temperature

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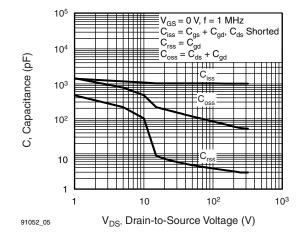


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

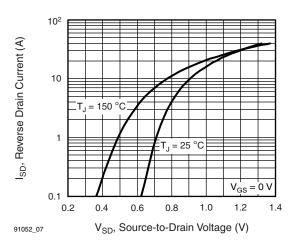


Fig. 7 - Typical Source-Drain Diode Forward Voltage

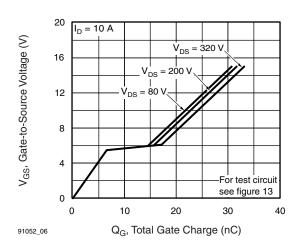


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

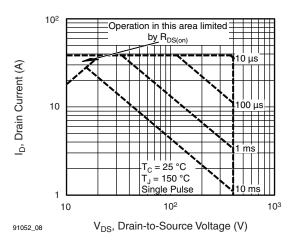


Fig. 8 - Maximum Safe Operating Area

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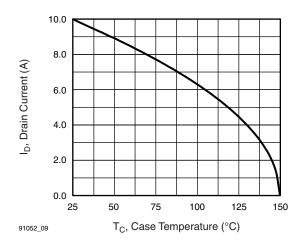


Fig. 9 - Maximum Drain Current vs. Case Temperature

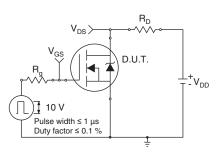


Fig. 10a - Switching Time Test Circuit

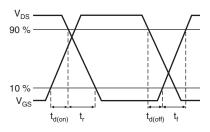


Fig. 10b - Switching Time Waveforms

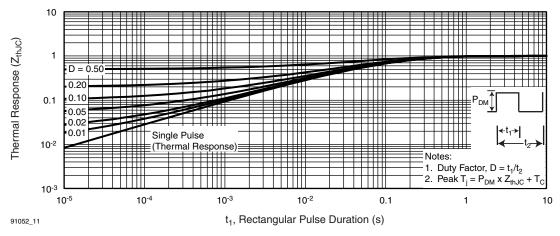


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

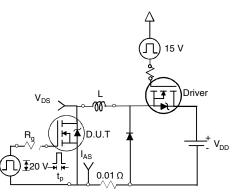


Fig. 12a - Unclamped Inductive Test Circuit

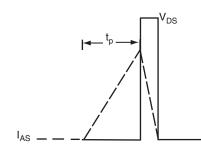


Fig. 12b - Unclamped Inductive Waveforms

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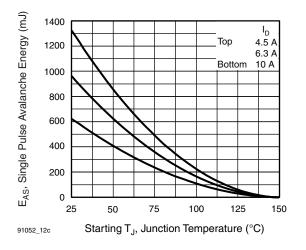


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

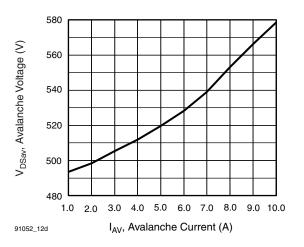


Fig. 12d - Typlical Drain-to-Source Voltage vs. Avalanche Current

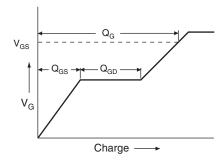


Fig. 13a - Basic Gate Charge Waveform

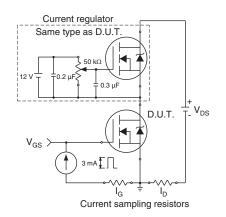
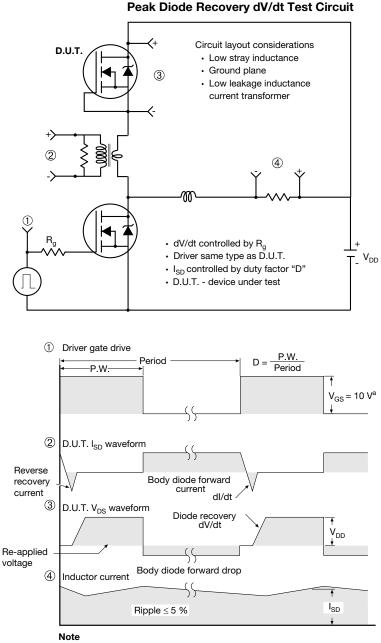


Fig. 13b - Gate Charge Test Circuit

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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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